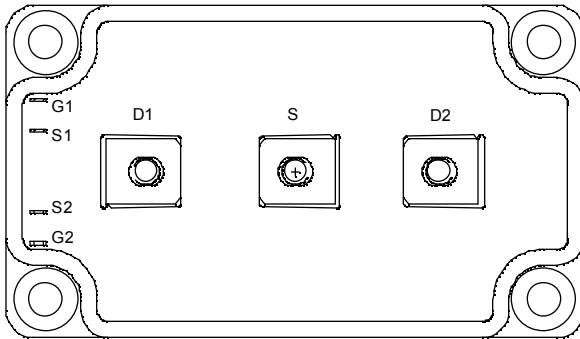
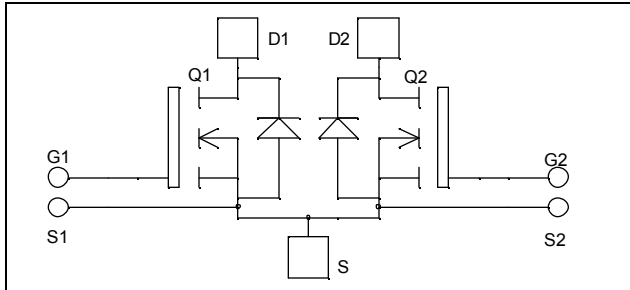


## Dual Common Source MOSFET Power Module

$$V_{DSS} = 1000V$$

$$R_{DSon} = 90m\Omega \text{ typ @ } T_j = 25^\circ C$$

$$I_D = 78A \text{ @ } T_c = 25^\circ C$$



### Application

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

### Features

- Power MOS 7<sup>®</sup> MOSFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile
- RoHS Compliant

### Absolute maximum ratings

| Symbol     | Parameter                                         | Max ratings        | Unit      |
|------------|---------------------------------------------------|--------------------|-----------|
| $V_{DSS}$  | Drain - Source Breakdown Voltage                  | 1000               | V         |
| $I_D$      | Continuous Drain Current                          | $T_c = 25^\circ C$ | A         |
|            |                                                   | $T_c = 80^\circ C$ |           |
| $I_{DM}$   | Pulsed Drain current                              | 312                |           |
| $V_{GS}$   | Gate - Source Voltage                             | $\pm 30$           | V         |
| $R_{DSon}$ | Drain - Source ON Resistance                      | 105                | $m\Omega$ |
| $P_D$      | Maximum Power Dissipation                         | $T_c = 25^\circ C$ | W         |
| $I_{AR}$   | Avalanche current (repetitive and non repetitive) | 25                 | A         |
| $E_{AR}$   | Repetitive Avalanche Energy                       | 50                 | mJ        |
| $E_{AS}$   | Single Pulse Avalanche Energy                     | 3000               |           |



**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

**All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified**

**Electrical Characteristics**

| Symbol       | Characteristic                  | Test Conditions                               | Min | Typ | Max       | Unit             |
|--------------|---------------------------------|-----------------------------------------------|-----|-----|-----------|------------------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}, V_{DS} = 1000\text{V}$   |     |     | 400       | $\mu\text{A}$    |
|              |                                 | $V_{GS} = 0\text{V}, V_{DS} = 800\text{V}$    |     |     | 2000      |                  |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10\text{V}, I_D = 39\text{A}$       |     | 90  | 105       | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_D = 10\text{mA}$          | 3   |     | 5         | V                |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$ |     |     | $\pm 250$ | nA               |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions                                                                                                                                            | Min | Typ  | Max | Unit |
|--------------|------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0\text{V}$<br>$V_{DS} = 25\text{V}$<br>$f = 1\text{MHz}$                                                                                         |     | 20.7 |     | nF   |
| $C_{oss}$    | Output Capacitance           |                                                                                                                                                            |     | 3.5  |     |      |
| $C_{rss}$    | Reverse Transfer Capacitance |                                                                                                                                                            |     | 0.64 |     |      |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10\text{V}$<br>$V_{Bus} = 500\text{V}$<br>$I_D = 78\text{A}$                                                                                     |     | 744  |     | nC   |
| $Q_{gs}$     | Gate – Source Charge         |                                                                                                                                                            |     | 96   |     |      |
| $Q_{gd}$     | Gate – Drain Charge          |                                                                                                                                                            |     | 488  |     |      |
| $T_{d(on)}$  | Turn-on Delay Time           | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}$<br>$V_{Bus} = 670\text{V}$<br>$I_D = 78\text{A}$<br>$R_G = 1.2\Omega$ |     | 18   |     | ns   |
| $T_r$        | Rise Time                    |                                                                                                                                                            |     | 12   |     |      |
| $T_{d(off)}$ | Turn-off Delay Time          |                                                                                                                                                            |     | 155  |     |      |
| $T_f$        | Fall Time                    |                                                                                                                                                            |     | 40   |     |      |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>25^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}, V_{Bus} = 670\text{V}$<br>$I_D = 78\text{A}, R_G = 1.2\Omega$          |     | 3.6  |     | mJ   |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                                            |     | 2.5  |     |      |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}, V_{Bus} = 670\text{V}$<br>$I_D = 78\text{A}, R_G = 1.2\Omega$         |     | 5.7  |     | mJ   |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                                            |     | 3.1  |     |      |

**Source - Drain diode ratings and characteristics**

| Symbol   | Characteristic                         | Test Conditions                                                               | Min | Typ  | Max | Unit          |
|----------|----------------------------------------|-------------------------------------------------------------------------------|-----|------|-----|---------------|
| $I_S$    | Continuous Source current (Body diode) | $T_c = 25^\circ\text{C}$                                                      |     |      | 78  | A             |
|          |                                        | $T_c = 80^\circ\text{C}$                                                      |     |      | 59  |               |
| $V_{SD}$ | Diode Forward Voltage                  | $V_{GS} = 0\text{V}, I_S = -78\text{A}$                                       |     |      | 1.3 | V             |
| $dv/dt$  | Peak Diode Recovery ❶                  |                                                                               |     |      | 10  | V/ns          |
| $t_{rr}$ | Reverse Recovery Time                  | $I_S = -78\text{A}, V_R = 670\text{V}$<br>$di_S/dt = 400\text{A}/\mu\text{s}$ |     | 1170 |     | ns            |
| $Q_{rr}$ | Reverse Recovery Charge                |                                                                               |     | 65.1 |     | $\mu\text{C}$ |

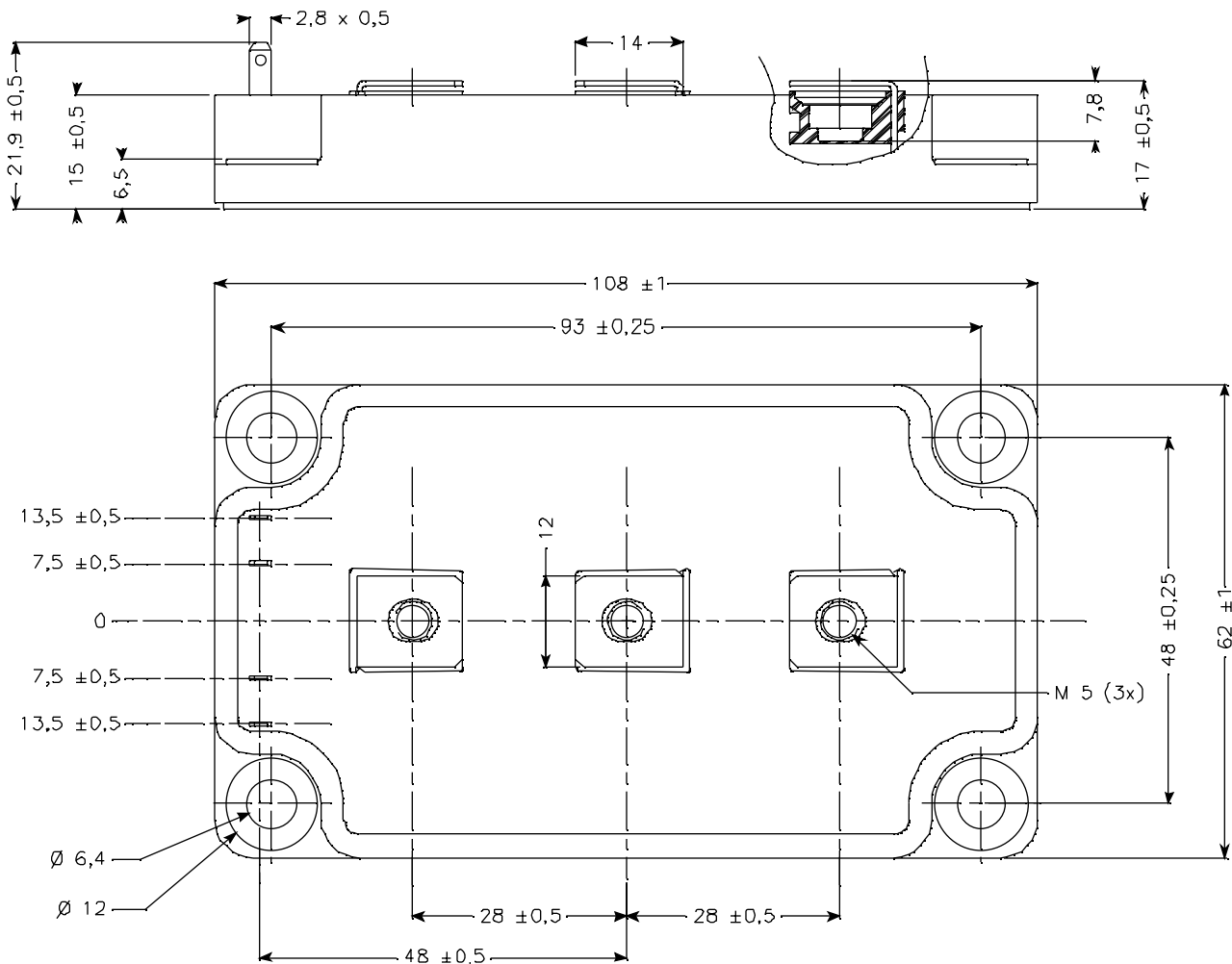
❶  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

$I_S \leq -78\text{A}$      $di/dt \leq 700\text{A}/\mu\text{s}$      $V_R \leq V_{DSS}$      $T_j \leq 150^\circ\text{C}$

## Thermal and package characteristics

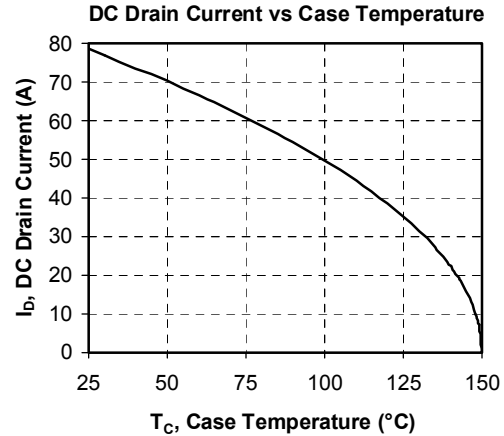
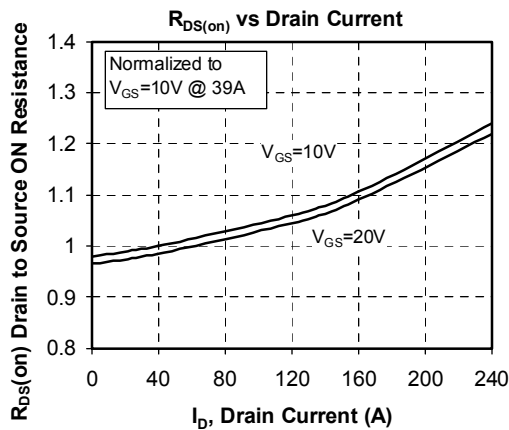
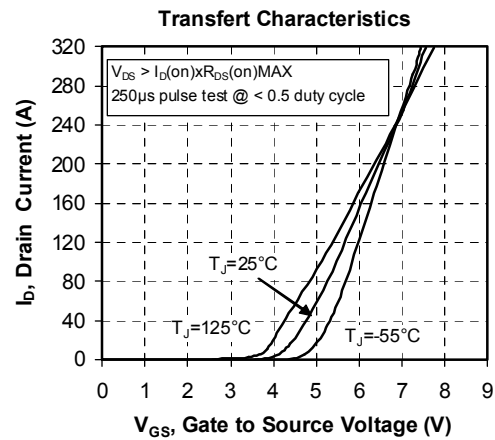
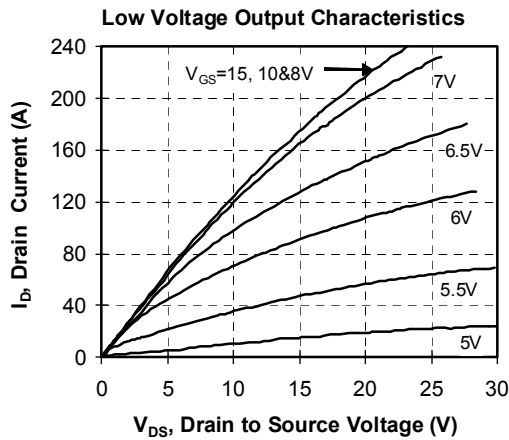
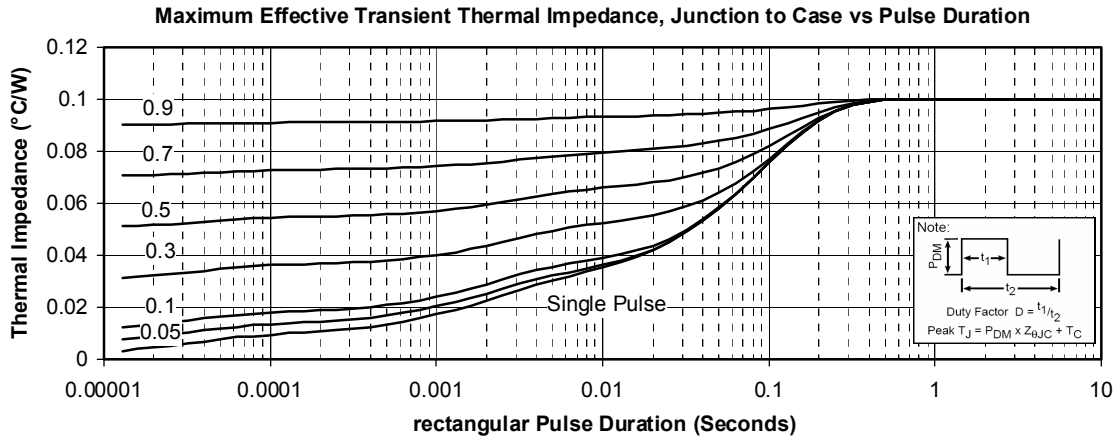
| Symbol     | Characteristic                                                                  | Min           | Typ | Max | Unit |
|------------|---------------------------------------------------------------------------------|---------------|-----|-----|------|
| $R_{thJC}$ | Junction to Case Thermal Resistance                                             |               |     | 0.1 | °C/W |
| $V_{ISOL}$ | RMS Isolation Voltage, any terminal to case $t=1$ min, $I_{isol}<1mA$ , 50/60Hz | 2500          |     |     | V    |
| $T_J$      | Operating junction temperature range                                            | -40           |     | 150 | °C   |
| $T_{STG}$  | Storage Temperature Range                                                       | -40           |     | 125 |      |
| $T_C$      | Operating Case Temperature                                                      | -40           |     | 100 |      |
| Torque     | Mounting torque                                                                 | To heatsink   | M6  | 3   | N.m  |
|            |                                                                                 | For terminals | M5  | 2   |      |
| Wt         | Package Weight                                                                  |               |     | 280 | g    |

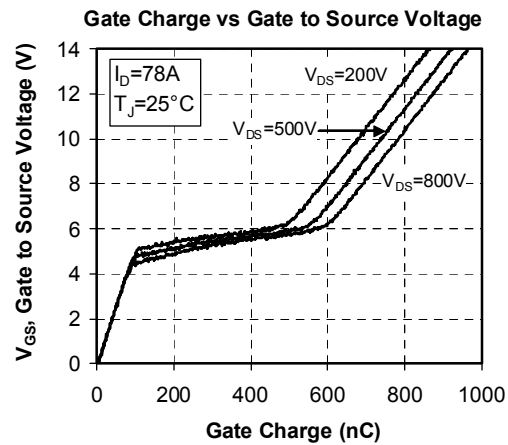
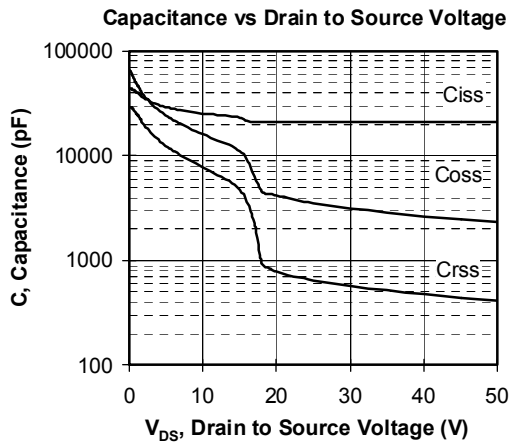
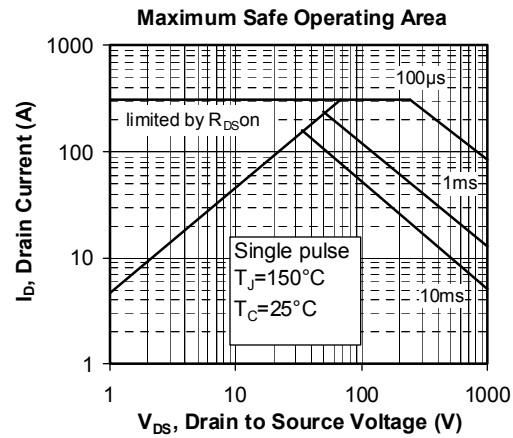
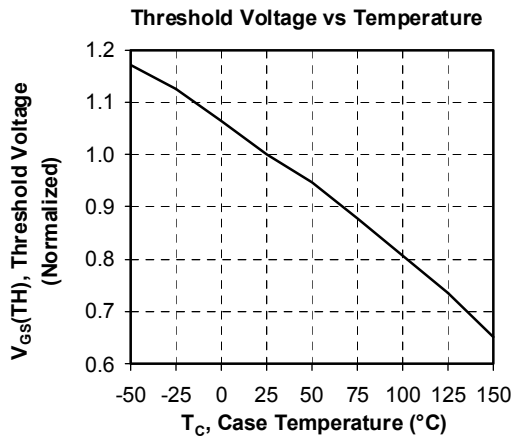
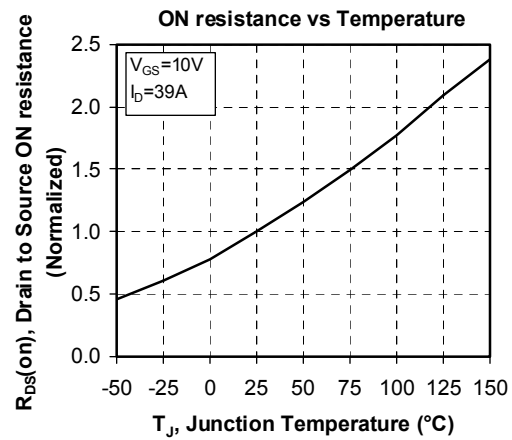
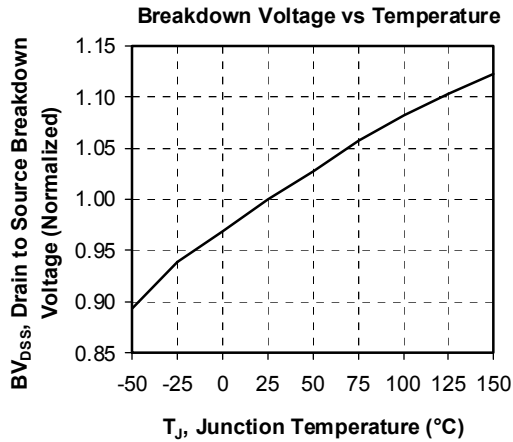
## SP6 Package outline (dimensions in mm)

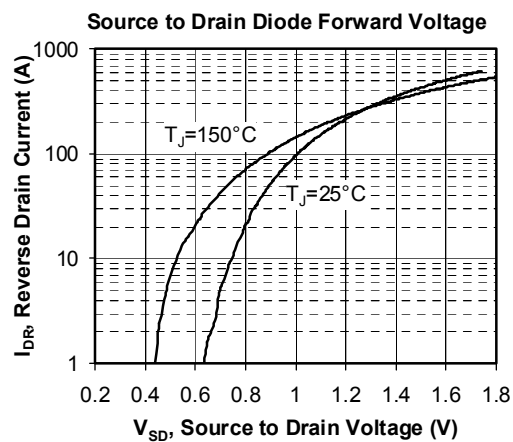
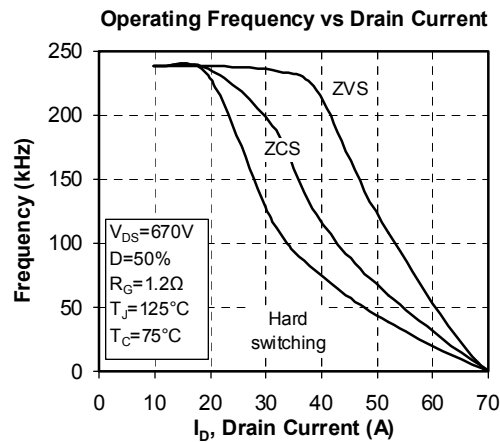
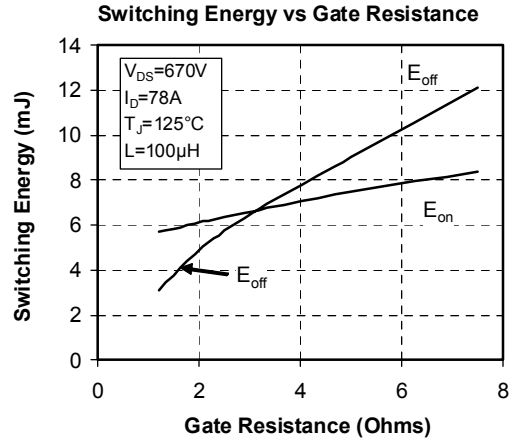
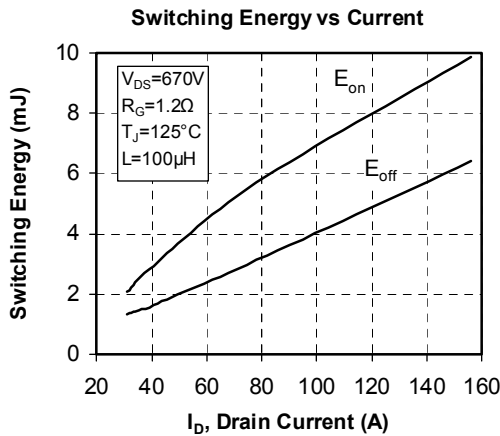
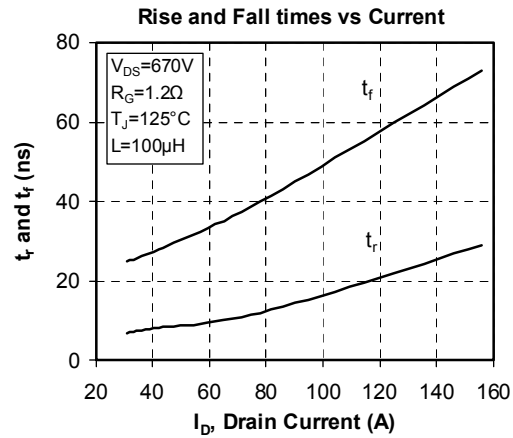
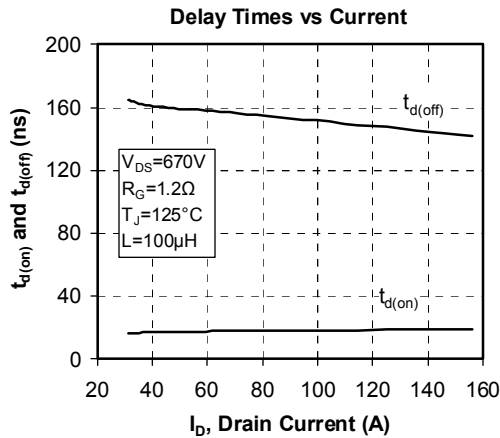


See application note APT0601 - Mounting Instructions for SP6 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve







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